

Operation: SMT&Push-Push 自彈外焊型超薄TF卡座

RoHS Compliant

LTEM NO.: TF-013 (Consumer Electronics)

(15.95L × 14.00W × 1.68H & T-Flash Sockets)

MEMORY-CARD-SOCKETS



Technical parameter

外焊貼裝 SMT

PROJECT	LEVEL	A[better product]	B[average product]
		Electrical Properties Contact Rating Initial Contact Resistance Insulation Resistance Withstand Voltage There No Load Rated Load Storage temp.	25mA, 24V DC 30mΩ max. 100MΩ min.500V DC 500V AC for 1 minute 6,500 Cycles 5,500 Cycles -25℃~+85℃(Operating Temp:

側向導入 LATERAL

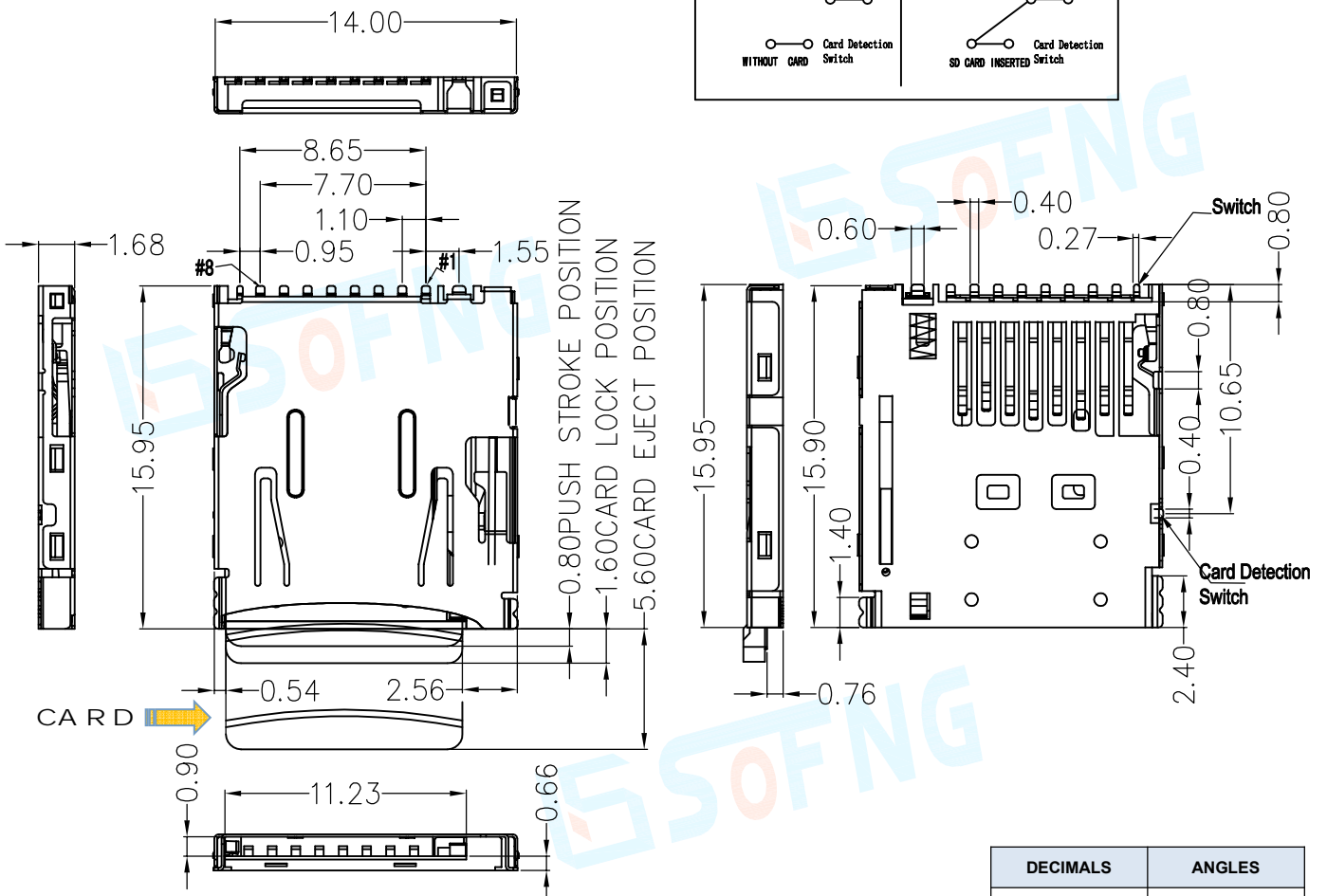
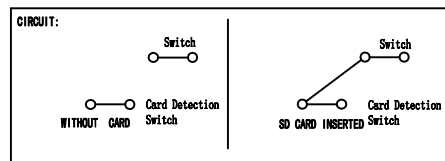
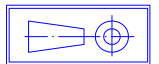
超薄部品 NICETY

可靠 STABILIZE

適合環保 RoHS

Page1

Unit:mm



DECIMALS	ANGLES
.X :±0.25	X.° :±1.5°
.XX :±0.15	XX.° :±1.0°
.XXX :±0.10	XXX.° :±0.5°

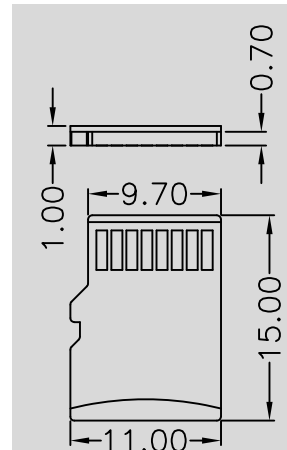
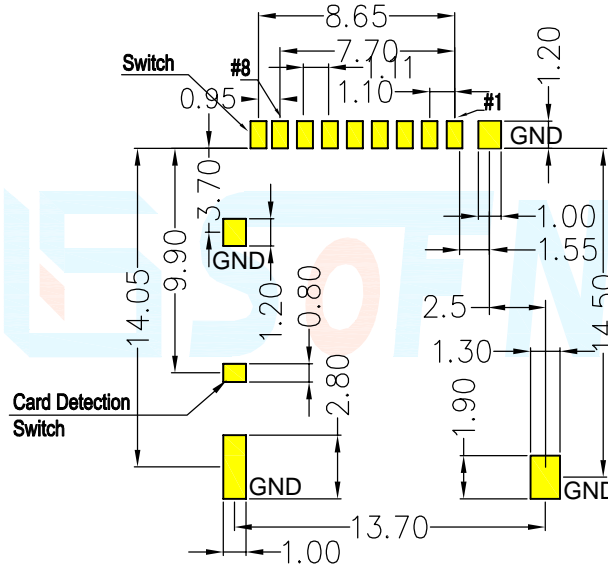


Operating Force

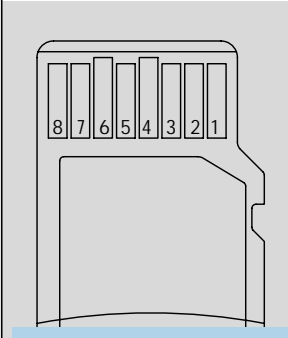
Inward 9.0~12.0N. (1N.=100gram-force)
 Exiting 5.0~8.0N. (1N.=100gram-force)

Solder-ability (Max.)

IR Reflow: 255°C, 5sec. Manual: 350°C, 3sec.



T-Flash

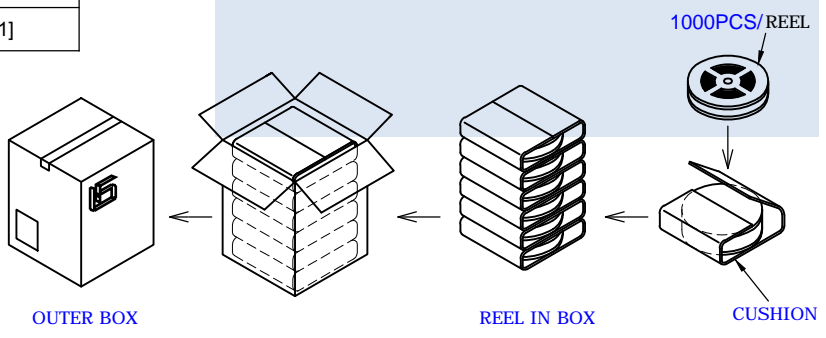


Pin definition



T-Flash CARD			
Pin No.	Pin NAME	Type	Description
P①	DAT2	I/O/PP	Date Line [Bit 2]
P②	CD/DAT3	I/O/PP	Card Detect Date Lin (Bit 3)
P③	CMD	PP	Command Response
P④	VDD	S	Supply voltage
P⑤	CLX	I	Clock
P⑥	Vss	S	Supply voltage ground
P⑦	DAT 0	I/O/PP	Date Line [Bit 0]
P⑧	DAT 1	I/O/PP	Date Line [Dit 1]

Material declaration			
No.	NAME	MATERIAL	PLATING
① A	基座	LCP 30%G/F (Black)耐热塑胶	-
② B	滑块	PA6T 30%G/F (Black)耐热尼龙	SET
③ C	接触端子	C5191R-H (t=0.15mm)磷青铜【锡 30u" 基镀金 1u"】	G/F
④ D	外壳	SUS301-3/4H(t=0.15mm)不锈钢【焊点镀金 1u"】	G/F
⑤ E	线簧	象唛钢线 OD=0.21mm	-
⑥ F	弹簧	SUS304(t=0.30mm)不锈钢	-
⑦ G	检测端子	C5191R-H (t=0.15mm)磷青铜【锡 30u" 基镀金 1u"】	G/F



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